

**INTEGRATED CIRCUITS**

# DATA SHEET

## **74AHC574; 74AHCT574**

Octal D-type flip-flop; positive  
edge-trigger; 3-state

Product specification  
File under Integrated Circuits, IC06

1999 Jun 16

**Octal D-type flip-flop; positive edge-trigger; 3-state****74AHC574;  
74AHCT574****FEATURES**

- 3-state non-inverting outputs for bus oriented applications
- 8-bit positive, edge-triggered register
- ESD protection:  
HBM EIA/JESD22-A114-A exceeds 2000 V  
MM EIA/JESD22-A115-A exceeds 200 V
- Independent register and 3-state buffer operation
- Common 3-state output enable input
- Output capability; bus driver
- I<sub>CC</sub> category: MSI
- For AHC only:  
operates with CMOS input levels
- For AHCT only:  
operates with TTL input levels
- Specified from  
−40 to +85 and +125 °C.

**DESCRIPTION**

The 74AHC/AHCT574 are high-speed Si-gate CMOS devices and are pin compatible with low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74AHC/AHCT574 are octal D-type flip-flops featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications. A clock (CP) and an output enable ( $\overline{OE}$ ) input are common to all flip-flops.

The 8 flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When  $\overline{OE}$  is LOW the contents of the 8 flip-flops are available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops.

The '574' is functionally identical to the '564', but has non-inverting outputs. The '574' is functionally identical to the '374', but has a different pinning.

**QUICK REFERENCE DATA**

GND = 0 V; T<sub>amb</sub> = 25 °C; t<sub>r</sub> = t<sub>f</sub> ≤ 3.0 ns.

| SYMBOL                             | PARAMETER                                 | CONDITIONS                                          | TYPICAL |      | UNIT |
|------------------------------------|-------------------------------------------|-----------------------------------------------------|---------|------|------|
|                                    |                                           |                                                     | AHC     | AHCT |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay<br>CP to Q <sub>n</sub> | C <sub>L</sub> = 15 pF; V <sub>CC</sub> = 5 V       | 4.4     | 4.4  | ns   |
| f <sub>max</sub>                   | maximum clock frequency                   | C <sub>L</sub> = 15 pF; V <sub>CC</sub> = 5 V       | 130     | 130  | MHz  |
| C <sub>I</sub>                     | input capacitance                         | V <sub>I</sub> = V <sub>CC</sub> or GND             | 4.0     | 4.0  | pF   |
| C <sub>O</sub>                     | output capacitance                        |                                                     | 4.0     | 4.0  | pF   |
| C <sub>PD</sub>                    | power dissipation<br>capacitance          | C <sub>L</sub> = 50 pF; f = 1 MHz;<br>notes 1 and 2 | 10      | 12   | pF   |

**Notes**

1. C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

$\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts.

2. The condition is V<sub>I</sub> = GND to V<sub>CC</sub>.

## Octal D-type flip-flop; positive edge-trigger; 3-state

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## FUNCTION TABLE

See note 1.

| OPERATING MODES                   | INPUTS                 |    |                | INTERNAL FLIP-FLOPS | OUTPUTS                          |
|-----------------------------------|------------------------|----|----------------|---------------------|----------------------------------|
|                                   | $\overline{\text{OE}}$ | CP | D <sub>n</sub> |                     | Q <sub>0</sub> to Q <sub>7</sub> |
| Load and read register            | L                      | ↑  | l              | L                   | L                                |
|                                   | L                      | ↑  | h              | H                   | H                                |
| Load register and disable outputs | H                      | ↑  | l              | L                   | Z                                |
|                                   | H                      | ↑  | h              | H                   | Z                                |

## Note

1. H = HIGH voltage level;  
h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition;  
L = LOW voltage level;  
l = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition;  
Z = high-impedance OFF-state;  
↑ = LOW-to-HIGH CP transition.

## ORDERING INFORMATION

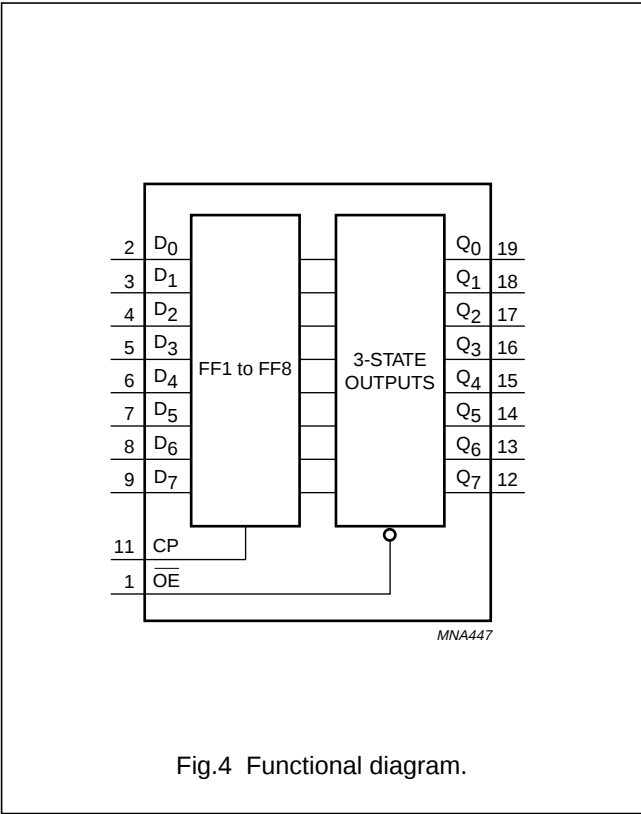
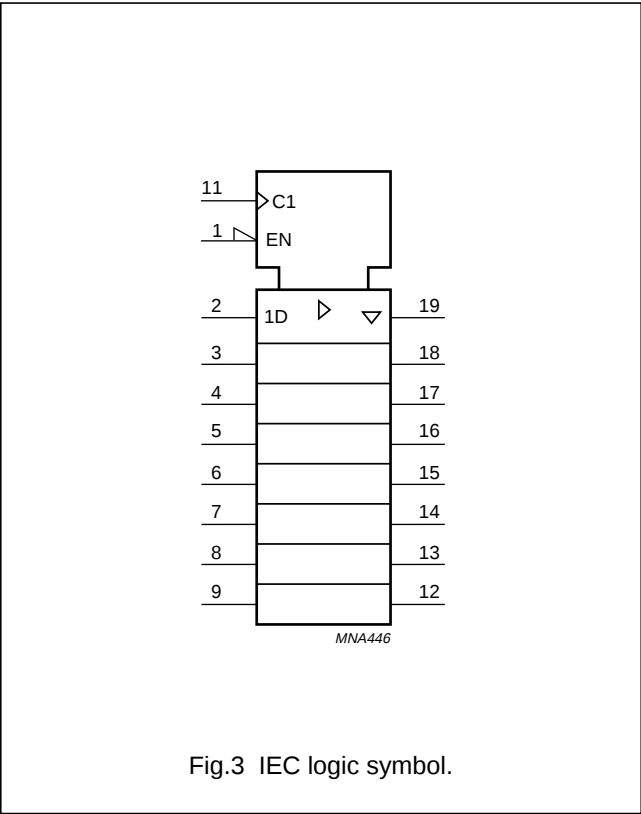
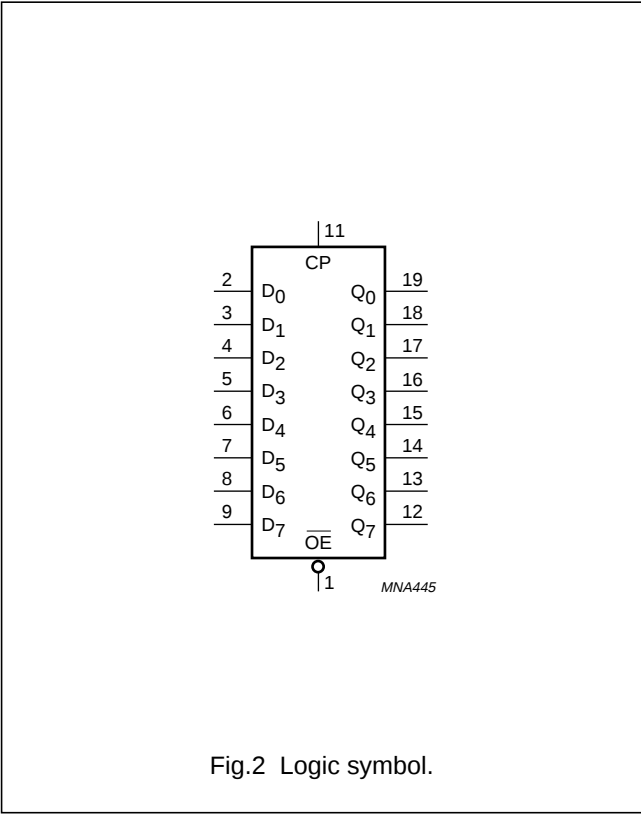
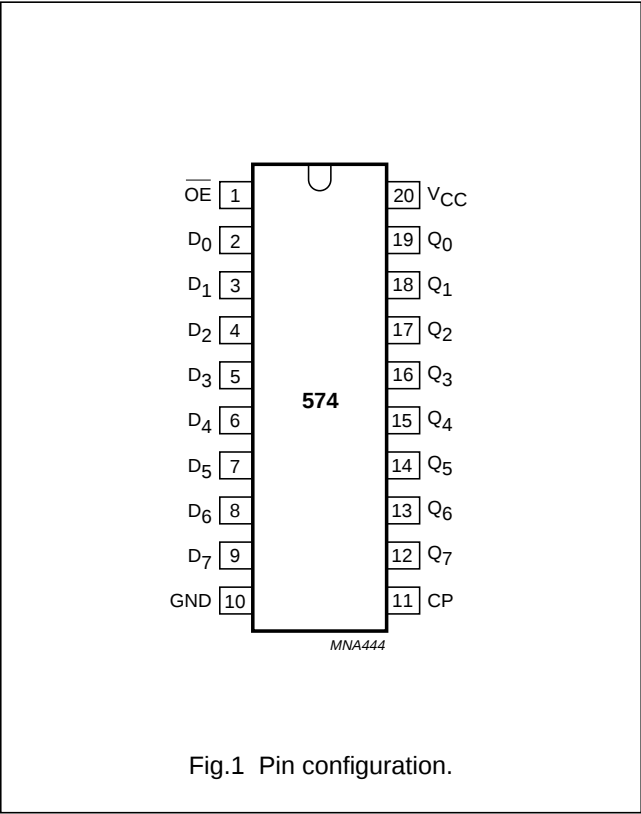
| OUTSIDE NORTH AMERICA | NORTH AMERICA  | PACKAGES |         |          |          |
|-----------------------|----------------|----------|---------|----------|----------|
|                       |                | PINS     | PACKAGE | MATERIAL | CODE     |
| 74AHC574D             | 74AHC574D      | 20       | SO      | plastic  | SOT163-1 |
| 74AHC574PW            | 74AHC574PW DH  | 20       | TSSOP   | plastic  | SOT360-1 |
| 74AHCT574D            | 74AHCT574D     | 20       | SO      | plastic  | SOT163-1 |
| 74AHCT574PW           | 74AHCT574PW DH | 20       | TSSOP   | plastic  | SOT360-1 |

## PINNING

| PIN                               | SYMBOL                           | DESCRIPTION                               |
|-----------------------------------|----------------------------------|-------------------------------------------|
| 1                                 | $\overline{\text{OE}}$           | 3-state output enable input (active LOW)  |
| 2, 3, 4, 5, 6, 7, 8 and 9         | D <sub>0</sub> to D <sub>7</sub> | data inputs                               |
| 10                                | GND                              | ground (0 V)                              |
| 11                                | CP                               | clock input (LOW-to-HIGH, edge triggered) |
| 19, 18, 17, 16, 15, 14, 13 and 12 | Q <sub>0</sub> to Q <sub>7</sub> | 3-state flip-flop outputs                 |
| 20                                | V <sub>CC</sub>                  | DC supply voltage                         |

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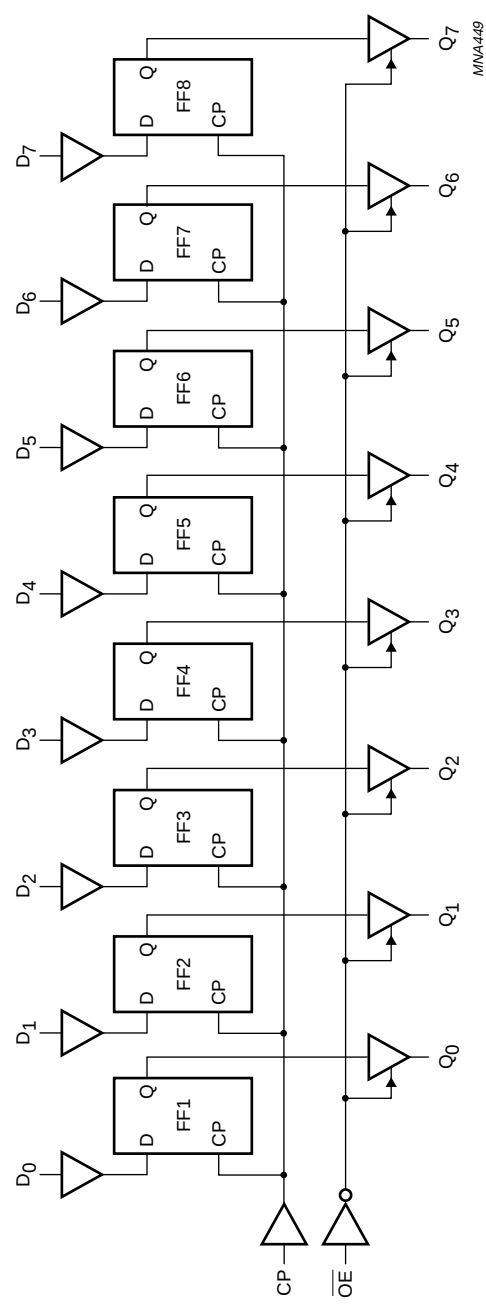


Fig.5 Logic diagram.

## Octal D-type flip-flop; positive edge-trigger; 3-state

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## RECOMMENDED OPERATING CONDITIONS

| SYMBOL                                  | PARAMETER                                                   | CONDITIONS                               | 74AHC |      |                 | 74AHCT |      |                 | UNIT |
|-----------------------------------------|-------------------------------------------------------------|------------------------------------------|-------|------|-----------------|--------|------|-----------------|------|
|                                         |                                                             |                                          | MIN.  | TYP. | MAX.            | MIN.   | TYP. | MAX.            |      |
| V <sub>CC</sub>                         | DC supply voltage                                           |                                          | 2.0   | 5.0  | 5.5             | 4.5    | 5.0  | 5.5             | V    |
| V <sub>I</sub>                          | input voltage                                               |                                          | 0     | –    | 5.5             | 0      | –    | 5.5             | V    |
| V <sub>O</sub>                          | output voltage                                              |                                          | 0     | –    | V <sub>CC</sub> | 0      | –    | V <sub>CC</sub> | V    |
| T <sub>amb</sub>                        | operating ambient temperature range                         | see DC and AC characteristics per device | –40   | +25  | +85             | –40    | +25  | +85             | °C   |
|                                         |                                                             |                                          | –40   | +25  | +125            | –40    | +25  | +125            | °C   |
| t <sub>r</sub> , t <sub>f</sub> (Δt/Δf) | input rise and fall times except for Schmitt-trigger inputs | V <sub>CC</sub> = 3.3 V ±0.3 V           | –     | –    | 100             | –      | –    | –               | ns/V |
|                                         |                                                             | V <sub>CC</sub> = 5 V ±0.5 V             | –     | –    | 20              | –      | –    | 20              | ns/V |

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134); voltages are referenced to GND (ground = 0 V).

| SYMBOL           | PARAMETER                         | CONDITIONS                                                                  | MIN. | MAX. | UNIT |
|------------------|-----------------------------------|-----------------------------------------------------------------------------|------|------|------|
| V <sub>CC</sub>  | DC supply voltage                 |                                                                             | –0.5 | +7.0 | V    |
| V <sub>I</sub>   | input voltage range               |                                                                             | –0.5 | +7.0 | V    |
| I <sub>IK</sub>  | DC input diode current            | V <sub>I</sub> < –0.5 V; note 1                                             | –    | –20  | mA   |
| I <sub>OK</sub>  | DC output diode current           | V <sub>O</sub> < –0.5 V or V <sub>O</sub> > V <sub>CC</sub> + 0.5 V; note 1 | –    | ±20  | mA   |
| I <sub>O</sub>   | DC output source or sink current  | –0.5 V < V <sub>O</sub> < V <sub>CC</sub> + 0.5 V                           | –    | ±25  | mA   |
| I <sub>CC</sub>  | DC V <sub>CC</sub> or GND current |                                                                             | –    | ±75  | mA   |
| T <sub>stg</sub> | storage temperature range         |                                                                             | –65  | +150 | °C   |
| P <sub>D</sub>   | power dissipation per package     | for temperature range: –40 to +125 °C; note 2                               | –    | 500  | mW   |

## Notes

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. For SO-packages: above 70 °C the value of P<sub>D</sub> derates linearly with 8 mW/K.  
For TSSOP-packages: above 60 °C the value of P<sub>D</sub> derates linearly with 5.5 mW/K.

## Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

## DC CHARACTERISTICS

## Family 74AHC

Over recommended operating conditions; voltage are referenced to GND (ground = 0 V).

| SYMBOL          | PARAMETER                              | TEST CONDITIONS                                                                                  |                     | T <sub>amb</sub> (°C) |      |       |            |      |             |       | UNIT |
|-----------------|----------------------------------------|--------------------------------------------------------------------------------------------------|---------------------|-----------------------|------|-------|------------|------|-------------|-------|------|
|                 |                                        | OTHER                                                                                            | V <sub>CC</sub> (V) | +25                   |      |       | –40 to +85 |      | –40 to +125 |       |      |
|                 |                                        |                                                                                                  |                     | MIN.                  | TYP. | MAX.  | MIN.       | MAX. | MIN.        | MAX.  |      |
| V <sub>IH</sub> | HIGH-level input voltage               |                                                                                                  | 2.0                 | 1.5                   | –    | –     | 1.5        | –    | 1.5         | –     | V    |
|                 |                                        |                                                                                                  | 3.0                 | 2.1                   | –    | –     | 2.1        | –    | 2.1         | –     |      |
|                 |                                        |                                                                                                  | 5.5                 | 3.85                  | –    | –     | 3.85       | –    | 3.85        | –     |      |
| V <sub>IL</sub> | LOW-level input voltage                |                                                                                                  | 2.0                 | –                     | –    | 0.5   | –          | 0.5  | –           | 0.5   | V    |
|                 |                                        |                                                                                                  | 3.0                 | –                     | –    | 0.9   | –          | 0.9  | –           | 0.9   |      |
|                 |                                        |                                                                                                  | 5.5                 | –                     | –    | 1.65  | –          | 1.65 | –           | 1.65  |      |
| V <sub>OH</sub> | HIGH-level output voltage; all outputs | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = –50 μA                 | 2.0                 | 1.9                   | 2.0  | –     | 1.9        | –    | 1.9         | –     | V    |
|                 |                                        |                                                                                                  | 3.0                 | 2.9                   | 3.0  | –     | 2.9        | –    | 2.9         | –     |      |
|                 |                                        |                                                                                                  | 4.5                 | 4.4                   | 4.5  | –     | 4.4        | –    | 4.4         | –     |      |
|                 | HIGH-level output voltage              | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = –4.0 mA                | 3.0                 | 2.58                  | –    | –     | 2.48       | –    | 2.40        | –     | V    |
|                 |                                        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = –8.0 mA                | 4.5                 | 3.94                  | –    | –     | 3.8        | –    | 3.70        | –     |      |
| V <sub>OL</sub> | LOW-level output voltage; all outputs  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = 50 μA                  | 2.0                 | –                     | 0    | 0.1   | –          | 0.1  | –           | 0.1   | V    |
|                 |                                        |                                                                                                  | 3.0                 | –                     | 0    | 0.1   | –          | 0.1  | –           | 0.1   |      |
|                 |                                        |                                                                                                  | 4.5                 | –                     | 0    | 0.1   | –          | 0.1  | –           | 0.1   |      |
|                 | LOW-level output voltage               | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = 4.0 mA                 | 3.0                 | –                     | –    | 0.36  | –          | 0.44 | –           | 0.55  | V    |
|                 |                                        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = 8.0 mA                 | 4.5                 | –                     | –    | 0.36  | –          | 0.44 | –           | 0.55  |      |
| I <sub>I</sub>  | input leakage current                  | V <sub>I</sub> = V <sub>CC</sub> or GND                                                          | 5.5                 | –                     | –    | 0.1   | –          | 1.0  | –           | 2.0   | μA   |
| I <sub>OZ</sub> | 3-state output OFF current             | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>V <sub>O</sub> = V <sub>CC</sub> or GND | 5.5                 | –                     | –    | ±0.25 | –          | ±2.5 | –           | ±10.0 | μA   |
| I <sub>CC</sub> | quiescent supply current               | V <sub>I</sub> = V <sub>CC</sub> or GND;<br>I <sub>O</sub> = 0                                   | 5.5                 | –                     | –    | 4.0   | –          | 40   | –           | 80    | μA   |
| C <sub>I</sub>  | input capacitance                      |                                                                                                  | –                   | –                     | 3    | 10    | –          | 10   | –           | 10    | pF   |

## Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

## Family 74AHCT

Over recommended operating conditions; voltage are referenced to GND (ground = 0 V).

| SYMBOL           | PARAMETER                                         | TEST CONDITIONS                                                                                                                                                                  |                     | T <sub>amb</sub> (°C) |      |       |            |      |             |       | UNIT |
|------------------|---------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|-----------------------|------|-------|------------|------|-------------|-------|------|
|                  |                                                   | OTHER                                                                                                                                                                            | V <sub>CC</sub> (V) | +25                   |      |       | –40 to +85 |      | –40 to +125 |       |      |
|                  |                                                   |                                                                                                                                                                                  |                     | MIN.                  | TYP. | MAX.  | MIN.       | MAX. | MIN.        | MAX.  |      |
| V <sub>IH</sub>  | HIGH-level input voltage                          |                                                                                                                                                                                  | 4.5 to 5.5          | 2.0                   | –    | –     | 2.0        | –    | 2.0         | –     | V    |
| V <sub>IL</sub>  | LOW-level input voltage                           |                                                                                                                                                                                  | 4.5 to 5.5          | –                     | –    | 0.8   | –          | 0.8  | –           | 0.8   | V    |
| V <sub>OH</sub>  | HIGH-level output voltage; all outputs            | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = –50 μA                                                                                                 | 4.5                 | 4.4                   | 4.5  | –     | 4.4        | –    | 4.4         | –     | V    |
|                  | HIGH-level output voltage                         | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = –8.0 mA                                                                                                | 4.5                 | 3.94                  | –    | –     | 3.8        | –    | 3.70        | –     | V    |
| V <sub>OL</sub>  | LOW-level output voltage; all outputs             | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = 50 μA                                                                                                  | 4.5                 | –                     | 0    | 0.1   | –          | 0.1  | –           | 0.1   | V    |
|                  | LOW-level output voltage                          | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>I <sub>O</sub> = 8.0 mA                                                                                                 | 4.5                 | –                     | –    | 0.36  | –          | 0.44 | –           | 0.55  | V    |
| I <sub>I</sub>   | input leakage current                             | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                                                                                              | 5.5                 | –                     | –    | 0.1   | –          | 1.0  | –           | 2.0   | μA   |
| I <sub>OZ</sub>  | 3-state output OFF current                        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>V <sub>O</sub> = V <sub>CC</sub> or GND per input pin;<br>other inputs at V <sub>CC</sub> or GND;<br>I <sub>O</sub> = 0 | 5.5                 | –                     | –    | ±0.25 | –          | ±2.5 | –           | ±10.0 | μA   |
| I <sub>CC</sub>  | quiescent supply current                          | V <sub>I</sub> = V <sub>CC</sub> or GND;<br>I <sub>O</sub> = 0                                                                                                                   | 5.5                 | –                     | –    | 4.0   | –          | 40   | –           | 80    | μA   |
| ΔI <sub>CC</sub> | additional quiescent supply current per input pin | V <sub>I</sub> = V <sub>CC</sub> – 2.1 V<br>other inputs at V <sub>CC</sub> or GND;<br>I <sub>O</sub> = 0                                                                        | 4.5 to 5.5          | –                     | –    | 1.35  | –          | 1.5  | –           | 1.5   | mA   |
| C <sub>I</sub>   | input capacitance                                 |                                                                                                                                                                                  | –                   | –                     | 3    | 10    | –          | 10   | –           | 10    | pF   |

## Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

## AC CHARACTERISTICS

## Type 74AHC574

GND = 0 V;  $t_r = t_f \leq 3.0$  ns.

| SYMBOL                             | PARAMETER                                           | TEST CONDITIONS     |                |                     | T <sub>amb</sub> (°C) |                    |      |            |      |             |      | UNIT |
|------------------------------------|-----------------------------------------------------|---------------------|----------------|---------------------|-----------------------|--------------------|------|------------|------|-------------|------|------|
|                                    |                                                     | WAVEFORMS           | C <sub>L</sub> | V <sub>CC</sub> (V) | +25                   |                    |      | −40 to +85 |      | −40 to +125 |      |      |
|                                    |                                                     |                     |                |                     | MIN.                  | TYP.               | MAX. | MIN.       | MAX. | MIN.        | MAX. |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay<br>CP to Q <sub>n</sub>           | see Figs 6, 8 and 9 | 15 pF          | 3.0 to 3.6          | –                     | 6.5 <sup>(1)</sup> | 13.2 | 1.0        | 15.5 | 1.0         | 16.5 | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | 3-state output enable time<br>OE to Q <sub>n</sub>  | see Figs 7 and 9    | 15 pF          |                     | –                     | 5.7 <sup>(1)</sup> | 12.8 | 1.0        | 15.0 | 1.0         | 16.0 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | 3-state output disable time<br>OE to Q <sub>n</sub> |                     |                |                     | –                     | 6.3 <sup>(1)</sup> | 13.0 | 1.0        | 15.0 | 1.0         | 16.5 | ns   |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay<br>CP to Q <sub>n</sub>           | see Figs 6, 8 and 9 | 50 pF          |                     | –                     | 9.3 <sup>(1)</sup> | 16.7 | 1.0        | 19.0 | 1.0         | 21.0 | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | 3-state output enable time<br>OE to Q <sub>n</sub>  | see Figs 7 and 9    |                |                     | –                     | 8.2 <sup>(1)</sup> | 16.3 | 1.0        | 18.5 | 1.0         | 20.5 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | 3-state output disable time<br>OE to Q <sub>n</sub> |                     |                |                     | –                     | 9.1 <sup>(1)</sup> | 15.0 | 1.0        | 17.0 | 1.0         | 19.0 | ns   |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay<br>CP to Q <sub>n</sub>           | see Figs 6, 8 and 9 | 15 pF          | 4.5 to 5.5          | –                     | 4.4 <sup>(2)</sup> | 8.6  | 1.0        | 10.0 | 1.0         | 11.0 | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | 3-state output enable time<br>OE to Q <sub>n</sub>  | see Figs 7 and 9    |                |                     | –                     | 4.2 <sup>(2)</sup> | 9.0  | 1.0        | 10.5 | 1.0         | 11.5 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | 3-state output disable time<br>OE to Q <sub>n</sub> |                     |                |                     | –                     | 4.3 <sup>(2)</sup> | 9.0  | 1.0        | 10.5 | 1.0         | 11.5 | ns   |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay<br>CP to Q <sub>n</sub>           | see Figs 6, 8 and 9 | 50 pF          |                     | –                     | 6.2 <sup>(2)</sup> | 10.6 | 1.0        | 12.0 | 1.0         | 13.5 | ns   |
| t <sub>PZH</sub> /t <sub>PZL</sub> | 3-state output enable time<br>OE to Q <sub>n</sub>  | see Figs 7 and 9    |                |                     | –                     | 5.9 <sup>(2)</sup> | 11.0 | 1.0        | 12.5 | 1.0         | 14.0 | ns   |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | 3-state output disable time<br>OE to Q <sub>n</sub> |                     |                |                     | –                     | 6.9 <sup>(2)</sup> | 10.1 | 1.0        | 11.5 | 1.0         | 13.0 | ns   |

Octal D-type flip-flop; positive edge-trigger; 3-state

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| SYMBOL           | PARAMETER                          | TEST CONDITIONS  |                |                     | T <sub>amb</sub> (°C) |      |      |            |      |             |      | UNIT |
|------------------|------------------------------------|------------------|----------------|---------------------|-----------------------|------|------|------------|------|-------------|------|------|
|                  |                                    | WAVEFORMS        | C <sub>L</sub> | V <sub>CC</sub> (V) | +25                   |      |      | –40 to +85 |      | –40 to +125 |      |      |
|                  |                                    |                  |                |                     | MIN.                  | TYP. | MAX. | MIN.       | MAX. | MIN.        | MAX. |      |
| t <sub>W</sub>   | clock pulse width<br>HIGH or LOW   | see Figs 6 and 9 | 50 pF          | 3.0 to 3.6          | 5.0                   | –    | –    | 5.0        | –    | 5.0         | –    | ns   |
| t <sub>su</sub>  | setup time<br>D <sub>n</sub> to CP | see Figs 8 and 9 |                |                     | 3.5                   | –    | –    | 3.5        | –    | 3.5         | –    | ns   |
| t <sub>h</sub>   | hold time<br>D <sub>n</sub> to CP  |                  |                |                     | 1.5                   | –    | –    | 1.5        | –    | 1.5         | –    | ns   |
| f <sub>max</sub> | maximum clock pulse frequency      | see Figs 6 and 9 |                |                     | 15 pF                 | 50   | 75   | –          | 45   | –           | 45   | –    |
|                  |                                    |                  | 80             | 125                 |                       | –    | 65   | –          | 65   | –           | MHz  |      |
| t <sub>W</sub>   | clock pulse width<br>HIGH or LOW   | see Figs 6 and 9 | 50 pF          | 4.5 to 5.5          | 5.0                   | –    | –    | 5.0        | –    | 5.0         | –    | ns   |
| t <sub>su</sub>  | setup time<br>D <sub>n</sub> to CP | see Figs 8 and 9 |                |                     | 3.0                   | –    | –    | 3.0        | –    | 3.0         | –    | ns   |
| t <sub>h</sub>   | hold time<br>D <sub>n</sub> to CP  |                  |                |                     | 1.5                   | –    | –    | 1.5        | –    | 1.5         | –    | ns   |
| f <sub>max</sub> | maximum clock pulse frequency      | see Figs 6 and 9 |                |                     | 15 pF                 | 85   | 115  | –          | 75   | –           | 75   | –    |
|                  |                                    |                  | 130            | 180                 |                       | –    | 110  | –          | 110  | –           | MHz  |      |

**Notes**

1. Typical values at V<sub>CC</sub> = 3.3 V.
2. Typical values at V<sub>CC</sub> = 5.0 V.

## Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

## Type 74AHCT574

GND = 0 V;  $t_r = t_f \leq 3.0$  ns.

| SYMBOL                             | PARAMETER                                           | TEST CONDITIONS  |                |                     | T <sub>amb</sub> (°C) |                    |      |            |      |             |      |     | UNIT |
|------------------------------------|-----------------------------------------------------|------------------|----------------|---------------------|-----------------------|--------------------|------|------------|------|-------------|------|-----|------|
|                                    |                                                     | WAVEFORMS        | C <sub>L</sub> | V <sub>CC</sub> (V) | +25                   |                    |      | −40 to +85 |      | −40 to +125 |      |     |      |
|                                    |                                                     |                  |                |                     | MIN.                  | TYP.               | MAX. | MIN.       | MAX. | MIN.        | MAX. |     |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay<br>CP to Q <sub>n</sub>           | see Figs 6 and 9 | 15 pF          | 4.5 to 5.5          | –                     | 4.4 <sup>(1)</sup> | 8.6  | 1.0        | 10.0 | 1.0         | 11.0 | ns  |      |
| t <sub>PZH</sub> /t <sub>PZL</sub> | 3-state output enable time<br>OE to Q <sub>n</sub>  | see Figs 7 and 9 |                |                     | –                     | 4.3 <sup>(1)</sup> | 9.0  | 1.0        | 10.5 | 1.0         | 11.5 | ns  |      |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | 3-state output disable time<br>OE to Q <sub>n</sub> |                  |                |                     | –                     | 4.3 <sup>(1)</sup> | 9.0  | 1.0        | 10.5 | 1.0         | 11.5 | ns  |      |
| t <sub>PHL</sub> /t <sub>PLH</sub> | propagation delay<br>CP to Q <sub>n</sub>           | see Figs 6 and 9 | 50 pF          |                     | –                     | 6.3 <sup>(1)</sup> | 10.6 | 1.0        | 12.0 | 1.0         | 13.5 | ns  |      |
| t <sub>PZH</sub> /t <sub>PZL</sub> | 3-state output enable time<br>OE to Q <sub>n</sub>  | see Figs 7 and 9 |                |                     | –                     | 6.1 <sup>(1)</sup> | 11.0 | 1.0        | 12.5 | 1.0         | 14.0 | ns  |      |
| t <sub>PHZ</sub> /t <sub>PLZ</sub> | 3-state output disable time<br>OE to Q <sub>n</sub> |                  |                |                     | –                     | 6.2 <sup>(1)</sup> | 10.1 | 1.0        | 11.5 | 1.0         | 13.0 | ns  |      |
| t <sub>w</sub>                     | clock pulse width<br>HIGH or LOW                    | see Figs 6 and 9 |                |                     | 5.0                   | –                  | –    | 5.5        | –    | 5.5         | –    | ns  |      |
| t <sub>su</sub>                    | setup time<br>D <sub>n</sub> to CP                  | see Figs 8 and 9 |                |                     | 3.0                   | –                  | –    | 3.5        | –    | 3.5         | –    | ns  |      |
| t <sub>h</sub>                     | hold time<br>D <sub>n</sub> to CP                   |                  |                |                     | 1.5                   | –                  | –    | 1.5        | –    | 1.5         | –    | ns  |      |
| f <sub>max</sub>                   | maximum clock pulse frequency                       | see Figs 6 and 9 |                | 15 pF               | 85                    | 115                | –    | 75         | –    | 75          | –    | MHz |      |
|                                    |                                                     |                  |                |                     | 130                   | 180                | –    | 110        | –    | 110         | –    | MHz |      |

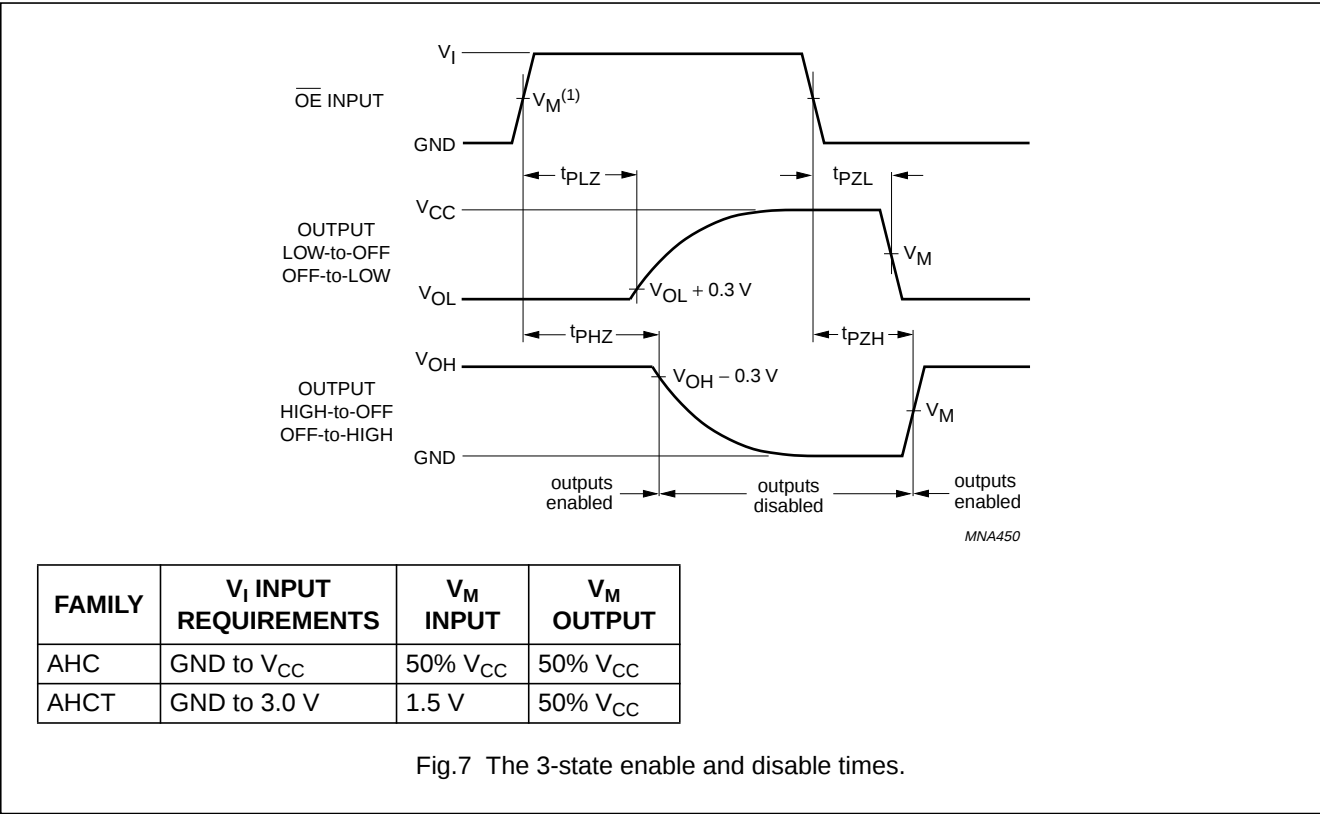
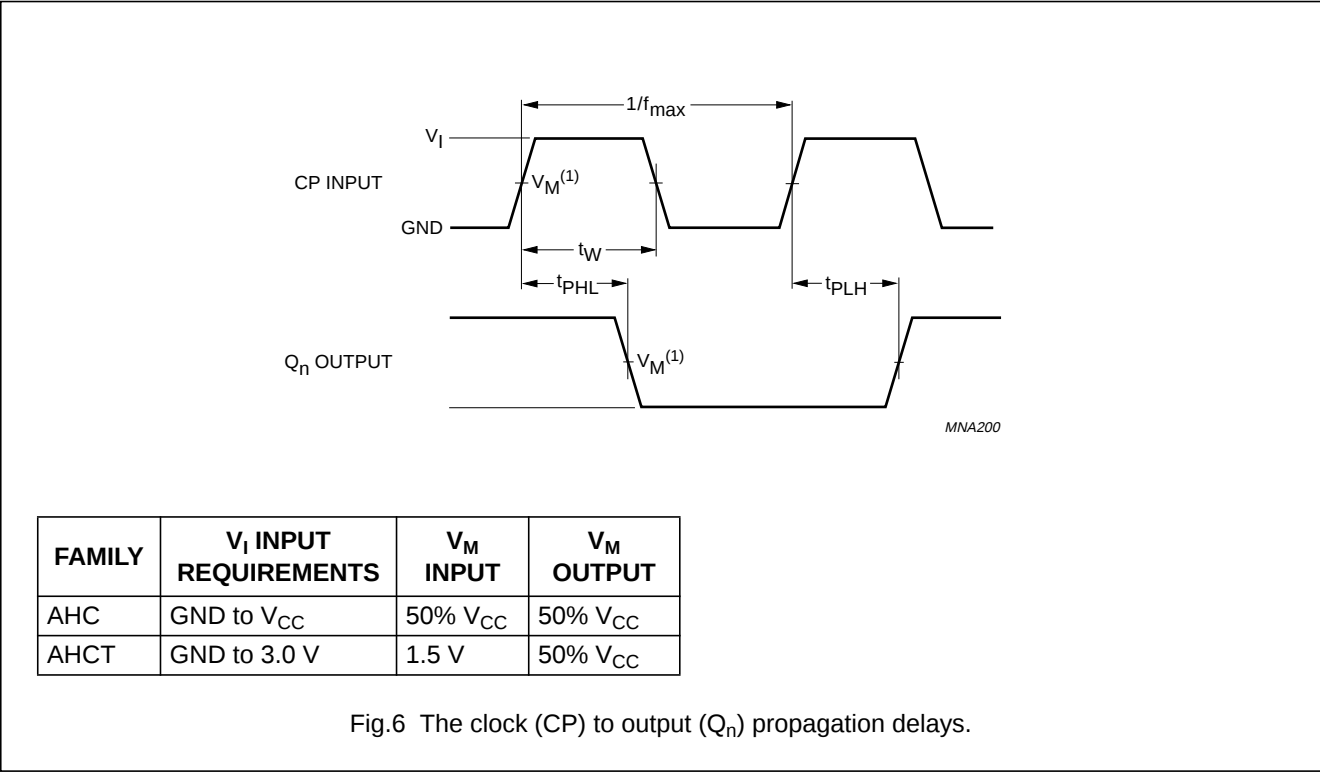
## Note

1. Typical values at  $V_{CC} = 5.0$  V.

Octal D-type flip-flop; positive edge-trigger; 3-state

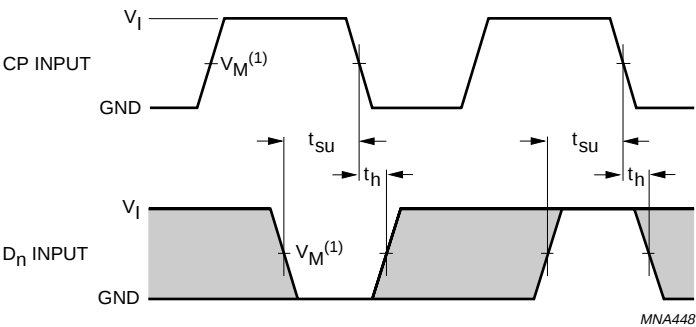
74AHC574;  
74AHCT574

AC WAVEFORMS



Octal D-type flip-flop; positive edge-trigger; 3-state

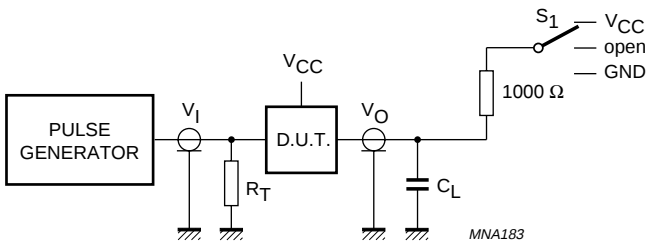
74AHC574;  
74AHCT574



| FAMILY | V <sub>I</sub> INPUT REQUIREMENTS | V <sub>M</sub> INPUT | V <sub>M</sub> OUTPUT |
|--------|-----------------------------------|----------------------|-----------------------|
| AHC    | GND to V <sub>CC</sub>            | 50% V <sub>CC</sub>  | 50% V <sub>CC</sub>   |
| AHCT   | GND to 3.0 V                      | 1.5 V                | 50% V <sub>CC</sub>   |

The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig.8 The data set-up and hold times for D<sub>n</sub> input.



| TEST                               | S <sub>1</sub>  |
|------------------------------------|-----------------|
| t <sub>PLH</sub> /t <sub>PHL</sub> | open            |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | V <sub>CC</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND             |

| FAMILY | V <sub>I</sub> INPUT REQUIREMENTS | V <sub>M</sub> INPUT | V <sub>M</sub> OUTPUT |
|--------|-----------------------------------|----------------------|-----------------------|
| AHC    | GND to V <sub>CC</sub>            | 50% V <sub>CC</sub>  | 50% V <sub>CC</sub>   |
| AHCT   | GND to 3.0 V                      | 1.5 V                | 50% V <sub>CC</sub>   |

Fig.9 Load circuitry for switching times.

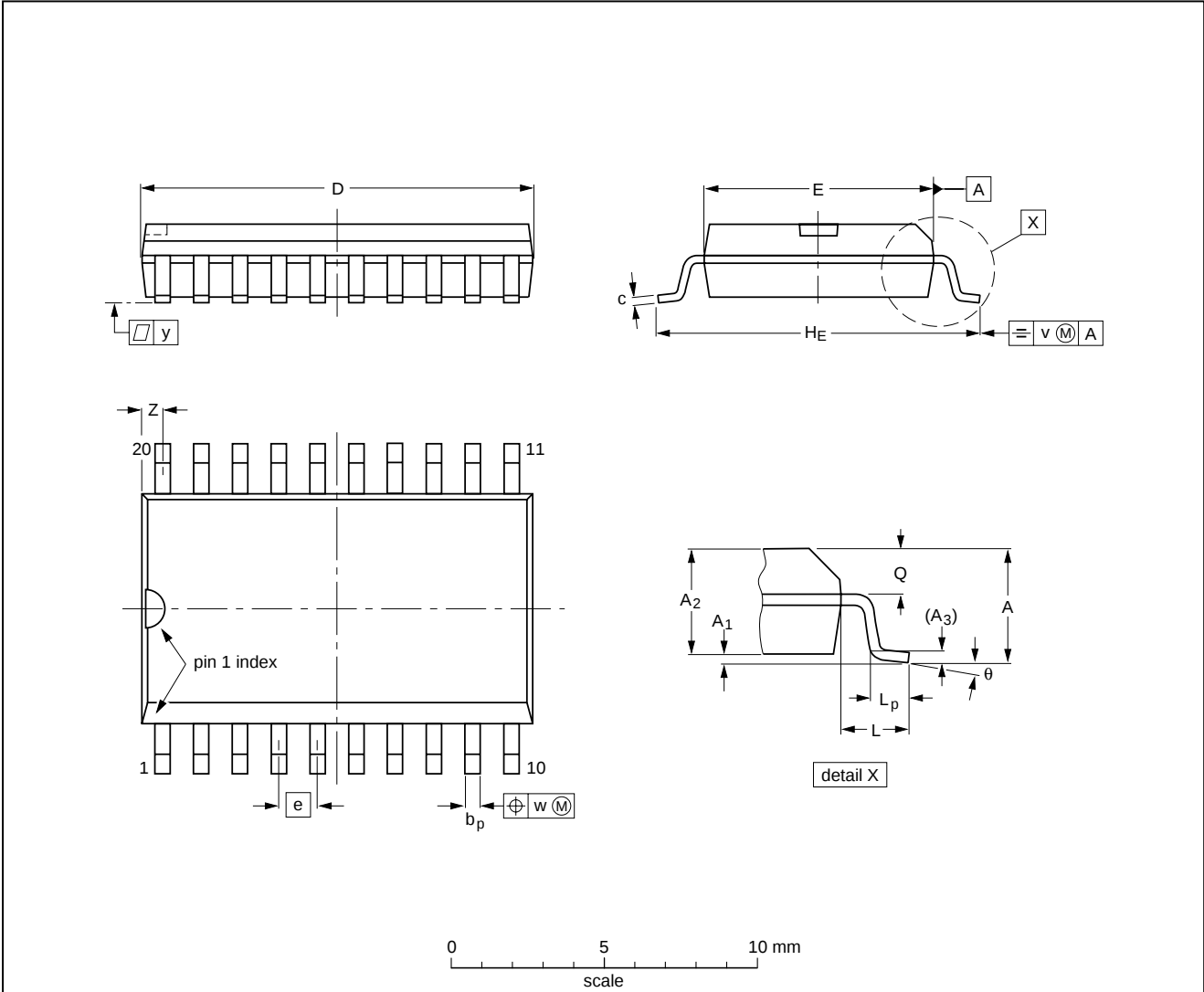
Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

PACKAGE OUTLINES

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c              | D <sup>(1)</sup> | E <sup>(1)</sup> | e     | H <sub>E</sub> | L     | L <sub>p</sub> | Q              | v    | w    | y     | Z <sup>(1)</sup> | θ        |
|--------|-----------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm     | 2.65      | 0.30<br>0.10   | 2.45<br>2.25   | 0.25           | 0.49<br>0.36   | 0.32<br>0.23   | 13.0<br>12.6     | 7.6<br>7.4       | 1.27  | 10.65<br>10.00 | 1.4   | 1.1<br>0.4     | 1.1<br>1.0     | 0.25 | 0.25 | 0.1   | 0.9<br>0.4       | 8°<br>0° |
| inches | 0.10      | 0.012<br>0.004 | 0.096<br>0.089 | 0.01           | 0.019<br>0.014 | 0.013<br>0.009 | 0.51<br>0.49     | 0.30<br>0.29     | 0.050 | 0.419<br>0.394 | 0.055 | 0.043<br>0.016 | 0.043<br>0.039 | 0.01 | 0.01 | 0.004 | 0.035<br>0.016   |          |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

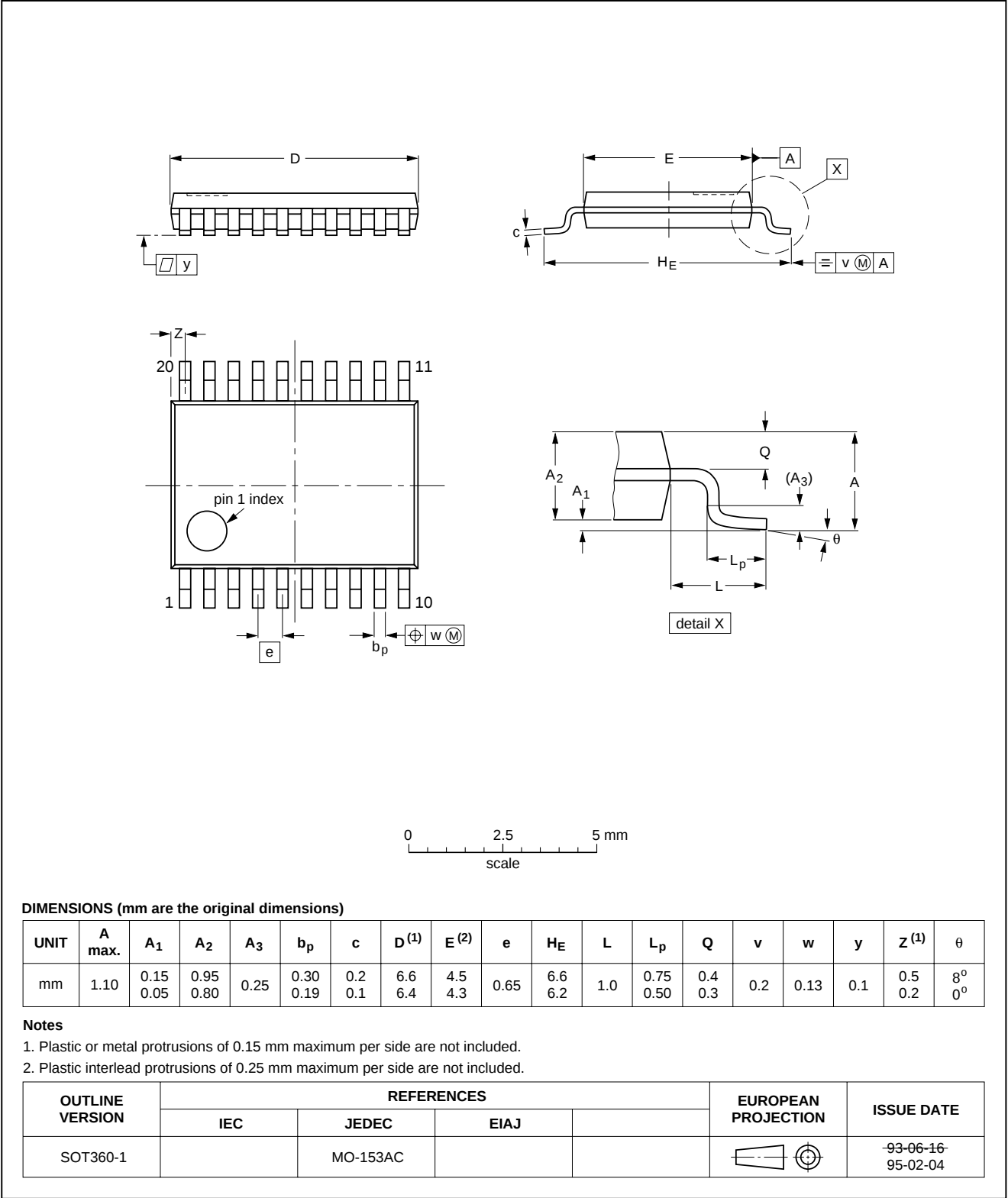
| OUTLINE<br>VERSION | REFERENCES |          |      |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|----------|------|--|------------------------|----------------------|
|                    | IEC        | JEDEC    | EIAJ |  |                        |                      |
| SOT163-1           | 075E04     | MS-013AC |      |  |                        | 95-01-24<br>97-05-22 |

Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



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Octal D-type flip-flop; positive edge-trigger; 3-state

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74AHC574;  
74AHCT574

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**SOLDERING****Introduction to soldering surface mount packages**

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"Data Handbook IC26; Integrated Circuit Packages"* (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering is not always suitable for surface mount ICs, or for printed-circuit boards with high population densities. In these situations reflow soldering is often used.

**Reflow soldering**

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, infrared/convection heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferably be kept below 230 °C.

**Wave soldering**

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
  - larger than or equal to 1.27 mm, the footprint longitudinal axis is **preferred** to be parallel to the transport direction of the printed-circuit board;
  - smaller than 1.27 mm, the footprint longitudinal axis **must** be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

- For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

**Manual soldering**

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

## Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

## Suitability of surface mount IC packages for wave and reflow soldering methods

| PACKAGE                       | SOLDERING METHOD                  |                       |
|-------------------------------|-----------------------------------|-----------------------|
|                               | WAVE                              | REFLOW <sup>(1)</sup> |
| BGA, SQFP                     | not suitable                      | suitable              |
| HLQFP, HSQFP, HSOP, SMS       | not suitable <sup>(2)</sup>       | suitable              |
| PLCC <sup>(3)</sup> , SO, SOJ | suitable                          | suitable              |
| LQFP, QFP, TQFP               | not recommended <sup>(3)(4)</sup> | suitable              |
| SSOP, TSSOP, VSO              | not recommended <sup>(5)</sup>    | suitable              |

## Notes

1. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the *"Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods"*.
2. These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
3. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
4. Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
5. Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

## DEFINITIONS

| Data sheet status                                                                                                                                                                                                                                                                                                                                                                                                                                         |                                                                                       |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| Objective specification                                                                                                                                                                                                                                                                                                                                                                                                                                   | This data sheet contains target or goal specifications for product development.       |
| Preliminary specification                                                                                                                                                                                                                                                                                                                                                                                                                                 | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification                                                                                                                                                                                                                                                                                                                                                                                                                                     | This data sheet contains final product specifications.                                |
| Limiting values                                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                       |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                                                                       |
| Application information                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                       |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                       |                                                                                       |

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Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

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NOTES

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Octal D-type flip-flop; positive edge-trigger; 3-state

74AHC574;  
74AHCT574

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NOTES

# Philips Semiconductors – a worldwide company

**Argentina:** see South America

**Australia:** 34 Waterloo Road, NORTH RYDE, NSW 2113,  
Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

**Austria:** Computerstr. 6, A-1101 WIEN, P.O. Box 213,  
Tel. +43 1 60 101 1248, Fax. +43 1 60 101 1210

**Belarus:** Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,  
220050 MINSK, Tel. +375 172 20 0733, Fax. +375 172 20 0773

**Belgium:** see The Netherlands

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**Bulgaria:** Philips Bulgaria Ltd., Energoproject, 15th floor,  
51 James Bourchier Blvd., 1407 SOFIA,  
Tel. +359 2 68 9211, Fax. +359 2 68 9102

**Canada:** PHILIPS SEMICONDUCTORS/COMPONENTS,  
Tel. +1 800 234 7381, Fax. +1 800 943 0087

**China/Hong Kong:** 501 Hong Kong Industrial Technology Centre,  
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,  
Tel. +852 2319 7888, Fax. +852 2319 7700

**Colombia:** see South America

**Czech Republic:** see Austria

**Denmark:** Sydhavnsgade 23, 1780 COPENHAGEN V,  
Tel. +45 33 29 3333, Fax. +45 33 29 3905

**Finland:** Sinikalliontie 3, FIN-02630 ESPOO,  
Tel. +358 9 615 800, Fax. +358 9 6158 0920

**France:** 51 Rue Carnot, BP317, 92156 SURESNES Cedex,  
Tel. +33 1 4099 6161, Fax. +33 1 4099 6427

**Germany:** Hammerbrookstraße 69, D-20097 HAMBURG,  
Tel. +49 40 2353 60, Fax. +49 40 2353 6300

**Hungary:** see Austria

**India:** Philips INDIA Ltd, Band Box Building, 2nd floor,  
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,  
Tel. +91 22 493 8541, Fax. +91 22 493 0966

**Indonesia:** PT Philips Development Corporation, Semiconductors Division,  
Gedung Philips, Jl. Buncit Raya Kav.99-100, JAKARTA 12510,  
Tel. +62 21 794 0040 ext. 2501, Fax. +62 21 794 0080

**Ireland:** Newstead, Clonskeagh, DUBLIN 14,  
Tel. +353 1 7640 000, Fax. +353 1 7640 200

**Israel:** RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,  
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

**Italy:** PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3,  
20124 MILANO, Tel. +39 02 67 52 2531, Fax. +39 02 67 52 2557

**Japan:** Philips Bldg 13-37, Kohnan 2-chome, Minato-ku,  
TOKYO 108-8507, Tel. +81 3 3740 5130, Fax. +81 3 3740 5057

**Korea:** Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,  
Tel. +82 2 709 1412, Fax. +82 2 709 1415

**Malaysia:** No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,  
Tel. +60 3 750 5214, Fax. +60 3 757 4880

**Mexico:** 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,  
Tel. +9-5 800 234 7381, Fax +9-5 800 943 0087

**Middle East:** see Italy

**Netherlands:** Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,  
Tel. +31 40 27 82785, Fax. +31 40 27 88399

**New Zealand:** 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,  
Tel. +64 9 849 4160, Fax. +64 9 849 7811

**Norway:** Box 1, Manglerud 0612, OSLO,  
Tel. +47 22 74 8000, Fax. +47 22 74 8341

**Pakistan:** see Singapore

**Philippines:** Philips Semiconductors Philippines Inc.,  
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,  
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

**Poland:** Ul. Lukiska 10, PL 04-123 WARSZAWA,  
Tel. +48 22 612 2831, Fax. +48 22 612 2327

**Portugal:** see Spain

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**Russia:** Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,  
Tel. +7 095 755 6918, Fax. +7 095 755 6919

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**South Africa:** S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,  
2092 JOHANNESBURG, P.O. Box 58088 Newville 2114,  
Tel. +27 11 471 5401, Fax. +27 11 471 5398

**South America:** Al. Vicente Pinzon, 173, 6th floor,  
04547-130 SÃO PAULO, SP, Brazil,  
Tel. +55 11 821 2333, Fax. +55 11 821 2382

**Spain:** Balmes 22, 08007 BARCELONA,  
Tel. +34 93 301 6312, Fax. +34 93 301 4107

**Sweden:** Kottbygatan 7, Akalla, S-16485 STOCKHOLM,  
Tel. +46 8 5985 2000, Fax. +46 8 5985 2745

**Switzerland:** Allmendstrasse 140, CH-8027 ZÜRICH,  
Tel. +41 1 488 2741 Fax. +41 1 488 3263

**Taiwan:** Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,  
TAIPEI, Taiwan Tel. +886 2 2134 2886, Fax. +886 2 2134 2874

**Thailand:** PHILIPS ELECTRONICS (THAILAND) Ltd.,  
209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,  
Tel. +66 2 745 4090, Fax. +66 2 398 0793

**Turkey:** Yukari Dudullu, Org. San. Blg., 2.Cad. Nr. 28 81260 Umraniye,  
ISTANBUL, Tel. +90 216 522 1500, Fax. +90 216 522 1813

**Ukraine:** PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,  
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

**United Kingdom:** Philips Semiconductors Ltd., 276 Bath Road, Hayes,  
MIDDLESEX UB3 5BX, Tel. +44 208 730 5000, Fax. +44 208 754 8421

**United States:** 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,  
Tel. +1 800 234 7381, Fax. +1 800 943 0087

**Uruguay:** see South America

**Vietnam:** see Singapore

**Yugoslavia:** PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,  
Tel. +381 11 62 5344, Fax. +381 11 63 5777

**For all other countries apply to:** Philips Semiconductors,  
International Marketing & Sales Communications, Building BE-p, P.O. Box 218,  
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Printed in The Netherlands

245002/01/pp20

Date of release: 1999 Jun 16

Document order number: 9397 750 06027

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